# 74LVT125; 74LVTH125

## 3.3 V quad buffer; 3-state

Rev. 8 — 18 August 2021 Product data sheet

## 1. General description

The 74LVT125; 74LVTH125 is a quad buffer/line driver with 3-state outputs controlled by the output enable inputs ($n\overline{OE}$). A HIGH on $n\overline{OE}$ causes the outputs to assume a high impedance OFF-state. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs. This device is fully specified for partial power down applications using $I_{OFF}$. The $I_{OFF}$ circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

## 2. Features and benefits

- Quad bus interface
- 3-state buffers
- Wide supply voltage range from 2.7 to 3.6 V
- BiCMOS high speed and output drive
- Output capability: +64 mA and -32 mA
- Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- No bus current loading when output is tied to 5 V bus
- Power-up 3-state
- $I_{OFF}$ circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- Complies with JEDEC standard JESD8C (2.7 V to 3.6 V)
- ESD protection:
  - HBM EIA/JESD22-A114-A exceeds 2000V
  - MM EIA/JESD22-A115-A exceeds 200V
- Specified from -40 °C to 85 °C

## 3. Ordering information

**Table 1. Ordering information**

| Type number | Package | | | |
|---|---|---|---|---|
| | Temperature range | Name | Description | Version |
| 74LVT125D | -40 °C to +85 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74LVTH125D | | | | |
| 74LVT125PW | -40 °C to +85 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74LVTH125PW | | | | |
| 74LVT125BQ | -40 °C to +85 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |
| 74LVTH125BQ | | | | |

## 4. Functional diagram

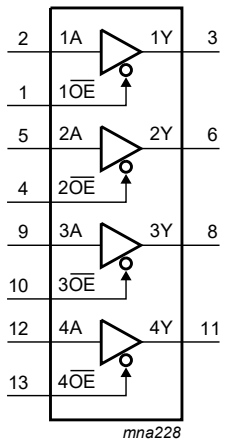



Fig. 1. Logic symbol

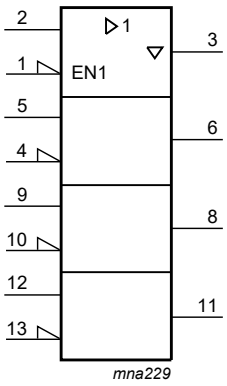



Fig. 2. IEC logic symbol

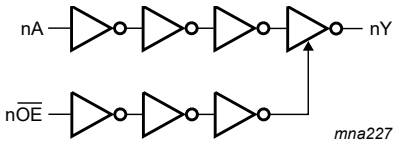



Fig. 3. Logic diagram (one buffer)

## 5. Pinning information

### 5.1. Pinning

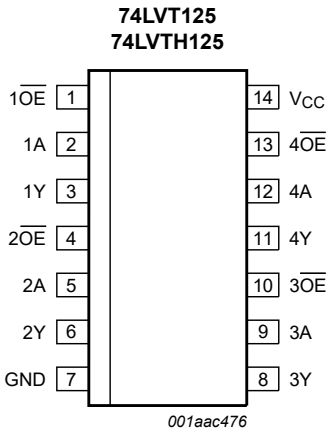
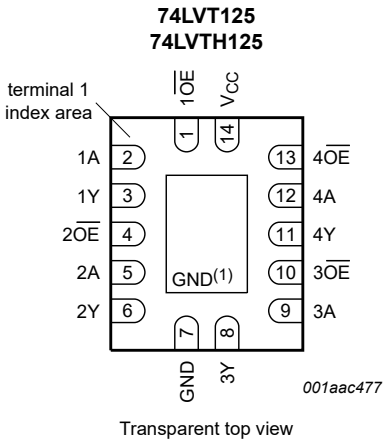



Fig. 4. Pin configuration SOT108-1 (SO14) and SOT402-1 (TSSOP14)




Transparent top view

(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

Fig. 5. Pin configuration SOT762-1 (DHVQFN14)

### 5.2. Pin description

**Table 2. Pin description**

| Symbol | Pin | Description |
|---|---|---|
| $1\overline{OE}$ | 1 | 1 output enable input (active LOW) |
| 1A | 2 | 1 data input |
| 1Y | 3 | 1 data output |
| $2\overline{OE}$ | 4 | 2 output enable input (active LOW) |
| 2A | 5 | 2 data input |
| 2Y | 6 | 2 data output |
| GND | 7 | ground (0 V) |
| 3Y | 8 | 3 data output |
| 3A | 9 | 3 data input |
| $3\overline{OE}$ | 10 | 3 output enable input (active LOW) |
| 4Y | 11 | 4 data output |
| 4A | 12 | 4 data input |
| $4\overline{OE}$ | 13 | 4 output enable input (active LOW) |
| $V_{CC}$ | 14 | supply voltage |

## 6. Functional description

**Table 3. Function table**

*H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.*

| Control | Input | Output |
|---|---|---|
| **$n\overline{OE}$** | **nA** | **nY** |
| L | L | L |
| L | H | H |
| H | X | Z |

# 7. Limiting values

**Table 4. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).*

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---|---|---|---|---|---|
| $V_{CC}$ | supply voltage | | -0.5 | +4.6 | V |
| $V_I$ | input voltage | [1] | -0.5 | +7.0 | V |
| $V_O$ | output voltage | output in OFF-state or HIGH-state [1] | -0.5 | +7.0 | V |
| $I_{IK}$ | input clamping current | $V_I$ < 0 V | - | -50 | mA |
| $I_{OK}$ | output clamping current | $V_O$ < 0 V | - | -50 | mA |
| $I_O$ | output current | output in LOW-state | - | 128 | mA |
| | | output in HIGH-state | - | -64 | mA |
| $T_{stg}$ | storage temperature | | -65 | +150 | °C |
| $T_j$ | junction temperature | [2] | - | 150 | °C |

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

# 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $V_{CC}$ | supply voltage | | 2.7 | - | 3.6 | V |
| $V_I$ | input voltage | | 0 | - | 5.5 | V |
| $V_{IH}$ | HIGH-level input voltage | | 2.0 | - | - | V |
| $V_{IL}$ | LOW-level input voltage | | - | - | 0.8 | V |
| $I_{OH}$ | HIGH-level output current | | - | - | -32 | mA |
| $I_{OL}$ | LOW-level output current | none | - | - | 32 | mA |
| | | current duty cycle ≤ 50 %;f ≥ 1 kHz | - | - | 64 | mA |
| Δt/ΔV | input transition rise and fall rate | | 0 | - | 10 | ns/V |
| $T_{amb}$ | ambient temperature | in free air | -40 | - | +85 | °C |

# 9. Static characteristics

**Table 6. Static characteristics**

*At recommended operating conditions; voltages are referenced to GND (ground = 0 V).*

| Symbol | Parameter | Conditions | Min | Typ [1] | Max | Unit |
|---|---|---|---|---|---|---|
| **$T_{amb}$ = -40 °C to +85 °C** | | | | | | |
| $V_{IK}$ | input clamping voltage | $I_{IK}$ = -18 mA; $V_{CC}$ = 2.7 V | - | -0.9 | -1.2 | V |
| $V_{OH}$ | HIGH-level output voltage | $I_{OH}$ = -100 µA; $V_{CC}$ = 2.7 V to 3.6 V | $V_{CC}$ - 0.2 | $V_{CC}$ - 0.1 | - | V |
| | | $I_{OH}$ = -8 mA; $V_{CC}$ = 2.7 V | 2.4 | 2.5 | - | V |
| | | $I_{OH}$ = -32 mA; $V_{CC}$ = 3.0 V | 2.0 | 2.2 | - | V |

| Symbol | Parameter | Conditions | Min | Typ [1] | Max | Unit |
|---|---|---|---|---|---|---|
| $V_{OL}$ | LOW-level output voltage | $V_{CC}$ = 2.7 V | | | | |
| | | $I_{OL}$ = 100 µA | - | 0.1 | 0.2 | V |
| | | $I_{OL}$ = 24 mA | - | 0.3 | 0.5 | V |
| | | $V_{CC}$ = 3.0 V | | | | |
| | | $I_{OL}$ = 16 mA | - | 0.25 | 0.4 | V |
| | | $I_{OL}$ = 32 mA | - | 0.3 | 0.5 | V |
| | | $I_{OL}$ = 64 mA | - | 0.4 | 0.55 | V |
| $I_I$ | input leakage current | all input pins | | | | |
| | | $V_{CC}$ = 0 V or 3.6 V; $V_I$ = 5.5 V | - | 1 | 10 | µA |
| | | control pins | | | | |
| | | $V_{CC}$ = 3.6 V; $V_I$ = $V_{CC}$ or GND | - | ±0.1 | ±1 | µA |
| | | data pins [2] | | | | |
| | | $V_{CC}$ = 3.6 V; $V_I$ = $V_{CC}$ | - | 0.1 | 1 | µA |
| | | $V_{CC}$ = 3.6 V; $V_I$ = 0 V | - | -1 | -5 | µA |
| $I_{OFF}$ | power-off leakage current | $V_{CC}$ = 0 V; $V_I$ or $V_O$ = 0 V to 4.5 V | - | 1 | ±100 | µA |
| $I_{BHL}$ | bus hold LOW current | $V_{CC}$ = 3 V; $V_I$ = 0.8 V [3] | 75 | 150 | - | µA |
| $I_{BHH}$ | bus hold HIGH current | $V_{CC}$ = 3 V; $V_I$ = 2.0 V | - | -150 | -75 | µA |
| $I_{BHLO}$ | bus hold LOW overdrive current | $V_{CC}$ = 3.6 V; $V_I$ = 0 V to 3.6 V | 500 | - | - | µA |
| $I_{BHHO}$ | bus hold HIGH overdrive current | $V_{CC}$ = 3.6 V; $V_I$ = 0 V to 3.6 V | - | - | -500 | µA |
| $I_{LO}$ | output leakage current | output in HIGH-state when $V_O$ > $V_{CC}$; $V_O$ = 5.5 V; $V_{CC}$ = 3.0 V | - | 60 | 125 | µA |
| $I_{O(pu/pd)}$ | power-up/power-down output current | $V_{CC}$ ≤ 1.2 V; $V_O$ = 0.5 V to $V_{CC}$; $V_I$ = GND or $V_{CC}$; n$\overline{OE}$ = don't care [4] | - | ±1 | ±100 | µA |
| $I_{OZ}$ | OFF-state output current | $V_{CC}$ = 3.6 V; $V_I$ = $V_{IH}$ or $V_{IL}$ | | | | |
| | | output HIGH: $V_O$ = 3.0 V | - | 1 | 5 | µA |
| | | output LOW: $V_O$ = 0.5 V | - | -1 | -5 | µA |
| $I_{CC}$ | supply current | $V_{CC}$ = 3.6 V; $V_I$ = GND or $V_{CC}$; $I_O$ = 0 A | | | | |
| | | outputs HIGH | - | 0.13 | 0.19 | mA |
| | | outputs LOW | - | 2 | 7 | mA |
| | | outputs disabled [5] | - | 0.13 | 0.19 | mA |
| $\Delta I_{CC}$ | additional supply current | per input pin; $V_{CC}$ = 3 V to 3.6 V; one input at $V_{CC}$ - 0.6 V and other inputs at $V_{CC}$ or GND [6] | - | 0.1 | 0.2 | mA |
| $C_I$ | input capacitance | $V_I$ = 0 V or 3.0 V | - | 4 | - | pF |
| $C_O$ | output capacitance | outputs disabled; $V_O$ = 0 V or 3.0 V | - | 8 | - | pF |

[1] Typical values are measured at $V_{CC}$ = 3.3 V and $T_{amb}$ = 25 °C.
[2] Unused pins at $V_{CC}$ or GND.
[3] This is the bus hold overdrive current required to force the input to the opposite logic state.
[4] This parameter is valid for any $V_{CC}$ between 0 V and 1.2 V with a transition time of up to 10 ms.
From $V_{CC}$ = 1.2 V to $V_{CC}$ = 3.0 V to 3.6 V a transition time of 100 µs is permitted. This parameter is valid for $T_{amb}$ = 25 °C only.
[5] $I_{CC}$ is measured with outputs pulled to $V_{CC}$ or GND.
[6] This is the increase in supply current for each input at the specified voltage level other than $V_{CC}$ or GND.

# 10. Dynamic characteristics

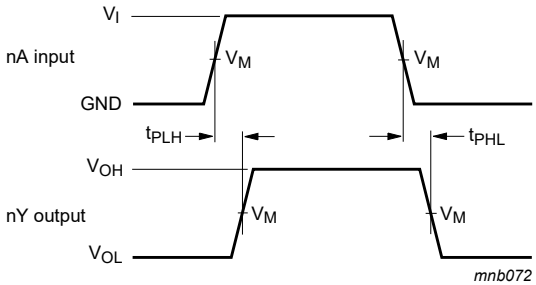
**Table 7. Dynamic characteristics**

*Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8.*

| Symbol | Parameter | Conditions | Min | Typ [1] | Max | Unit |
|---|---|---|---|---|---|---|
| **$T_{amb}$ = -40 °C to +85 °C** | | | | | | |
| $t_{PLH}$ | LOW to HIGH propagation delay | nAn to nY; see Fig. 6 | | | | |
| | | $V_{CC}$ = 2.7 V | - | - | 4.5 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.0 | 2.7 | 4.0 | ns |
| $t_{PHL}$ | HIGH to LOW propagation delay | nAn to nY; see Fig. 6 | | | | |
| | | $V_{CC}$ = 2.7 V | - | - | 4.9 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.0 | 2.9 | 3.9 | ns |
| $t_{PZH}$ | OFF-state to HIGH propagation delay | $n\overline{OE}$ to nY; see Fig. 7 | | | | |
| | | $V_{CC}$ = 2.7 V | - | - | 6.0 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.0 | 3.4 | 4.7 | ns |
| $t_{PZL}$ | OFF-state to LOW propagation delay | $n\overline{OE}$ to nY; see Fig. 7 | | | | |
| | | $V_{CC}$ = 2.7 V | - | - | 6.5 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.1 | 3.4 | 4.7 | ns |
| $t_{PHZ}$ | HIGH to OFF-state propagation delay | $n\overline{OE}$ to nY; see Fig. 7 | | | | |
| | | $V_{CC}$ = 2.7 V | - | - | 5.7 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.8 | 3.7 | 5.1 | ns |
| $t_{PLZ}$ | LOW to OFF-state propagation delay | $n\overline{OE}$ to nY; see Fig. 7 | | | | |
| | | $V_{CC}$ = 2.7 V | - | - | 4.0 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.3 | 2.6 | 4.5 | ns |

[1] Typical values are at $V_{CC}$ = 3.3 V and $T_{amb}$ = 25 °C.

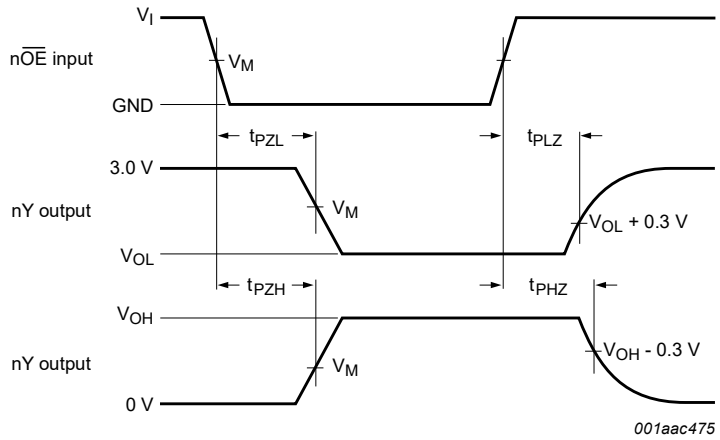
## 10.1. Waveforms and test circuit




$V_M$ = 1.5 V.

$V_{OL}$ and $V_{OH}$ are typical voltage output levels that occur with the output load.

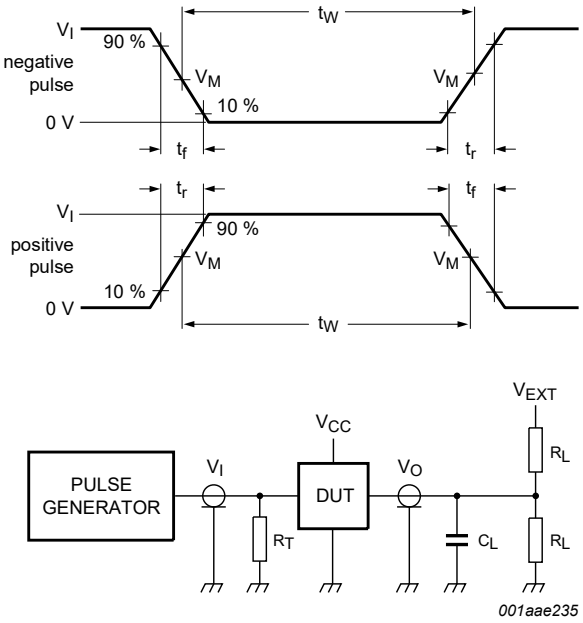
**Fig. 6. Propagation delay input (nA) to output (nY)**




$V_M$ = 1.5 V.

$V_{OL}$ and $V_{OH}$ are typical voltage output levels that occur with the output load.

**Fig. 7. Enable and disable times of 3-state outputs**




Test data is given in Table 8.

Definitions test circuit:

$R_L$ = Load resistance.

$C_L$ = Load capacitance including jig and probe capacitance.

$R_T$ = Termination resistance should be equal to output impedance $Z_o$ of the pulse generator.

$V_{EXT}$ = Test voltage for switching times.

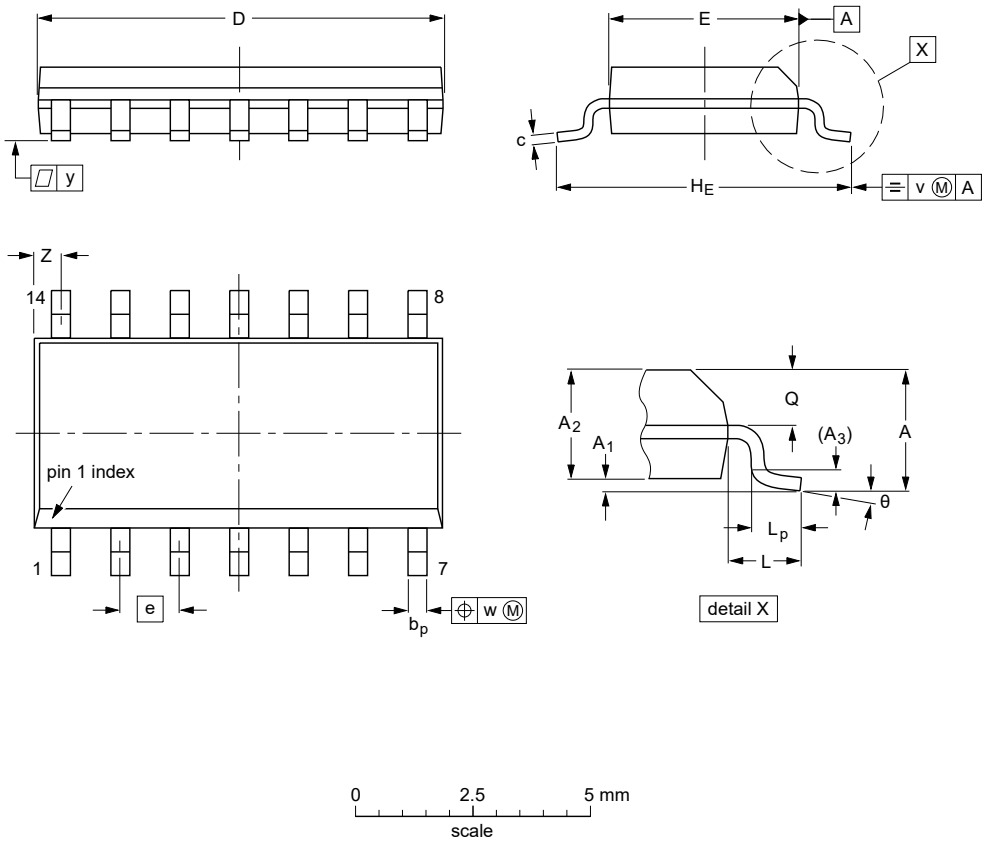
**Fig. 8. Test circuit for measuring switching times**

**Table 8. Test data**

| Input | | | | Load | | $V_{EXT}$ | | |
|---|---|---|---|---|---|---|---|---|
| $V_I$ | $f_i$ | $t_W$ | $t_r$, $t_f$ | $C_L$ | $R_L$ | $t_{PHZ}$, $t_{PZH}$ | $t_{PLZ}$, $t_{PZL}$ | $t_{PLH}$, $t_{PHL}$ |
| 2.7 V | ≤ 10 MHz | 500 ns | ≤ 2.5 ns | 50 pF | 500 Ω | GND | 6 V | open |

# 11. Package outline

**SO14: plastic small outline package; 14 leads; body width 3.9 mm** **SOT108-1**




**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

| UNIT | A max. | $A_1$ | $A_2$ | $A_3$ | $b_p$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $H_E$ | L | $L_p$ | Q | v | w | y | $Z^{(1)}$ | θ |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 1.75 | 0.25<br>0.10 | 1.45<br>1.25 | 0.25 | 0.49<br>0.36 | 0.25<br>0.19 | 8.75<br>8.55 | 4.0<br>3.8 | 1.27 | 6.2<br>5.8 | 1.05 | 1.0<br>0.4 | 0.7<br>0.6 | 0.25 | 0.25 | 0.1 | 0.7<br>0.3 | $8^{o}$<br>$0^{o}$ |
| inches | 0.069 | 0.010<br>0.004 | 0.057<br>0.049 | 0.01 | 0.019<br>0.014 | 0.0100<br>0.0075 | 0.35<br>0.34 | 0.16<br>0.15 | 0.05 | 0.244<br>0.228 | 0.041 | 0.039<br>0.016 | 0.028<br>0.024 | 0.01 | 0.01 | 0.004 | 0.028<br>0.012 | |

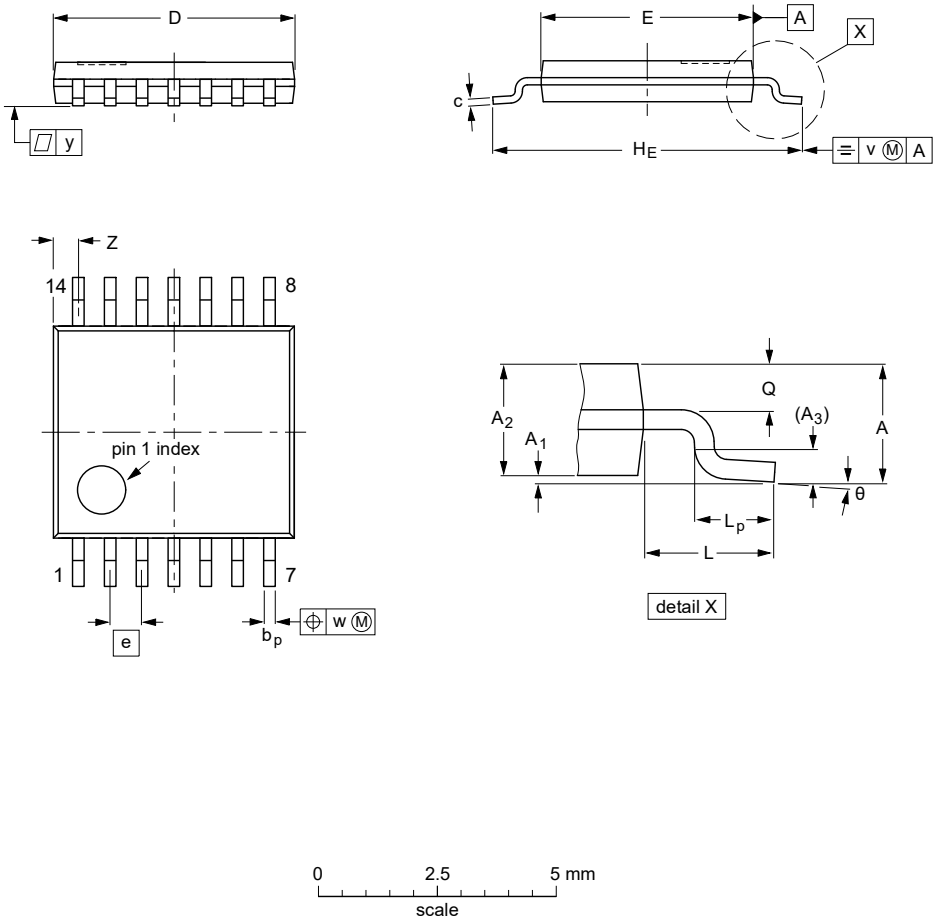
**Note**

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT108-1 | 076E06 | MS-012 | | | | ~~99-12-27~~<br>03-02-19 |

**Fig. 9. Package outline SOT108-1 (SO14)**

**TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm** **SOT402-1**




**DIMENSIONS (mm are the original dimensions)**

| UNIT | A max. | $A_1$ | $A_2$ | $A_3$ | $b_p$ | c | D (1) | E (2) | e | $H_E$ | L | $L_p$ | Q | v | w | y | Z (1) | θ |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 1.1 | 0.15<br>0.05 | 0.95<br>0.80 | 0.25 | 0.30<br>0.19 | 0.2<br>0.1 | 5.1<br>4.9 | 4.5<br>4.3 | 0.65 | 6.6<br>6.2 | 1 | 0.75<br>0.50 | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.72<br>0.38 | 8°<br>0° |

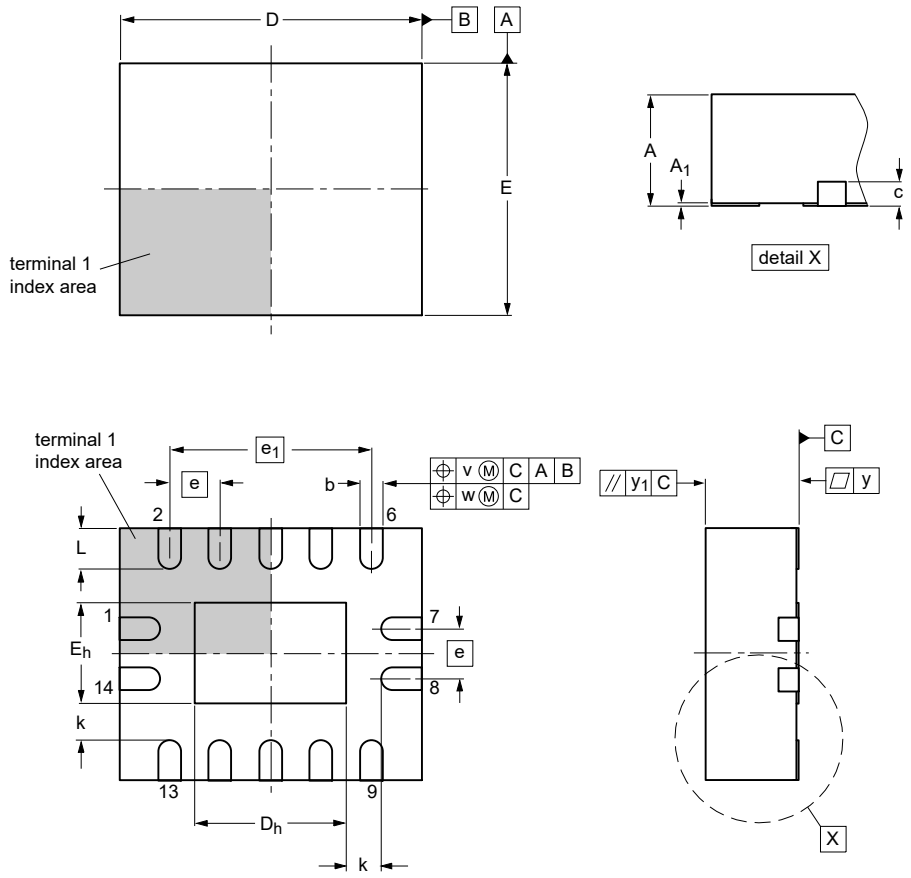
**Notes**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT402-1 | | MO-153 | | | | ~~99-12-27~~<br>03-02-18 |

**Fig. 10. Package outline SOT402-1 (TSSOP14)**

**DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm** **SOT762-1**




Dimensions (mm are the original dimensions)

| Unit | | $A^{(1)}$ | $A_1$ | b | c | $D^{(1)}$ | $D_h$ | $E^{(1)}$ | $E_h$ | e | $e_1$ | k | L | v | w | y | $y_1$ |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | max | 1 | 0.05 | 0.30 | | 3.1 | 1.65 | 2.6 | 1.15 | | | | 0.5 | | | | |
| mm | nom | | 0.02 | 0.25 | 0.2 | 3.0 | 1.50 | 2.5 | 1.00 | 0.5 | 2 | | 0.4 | 0.1 | 0.05 | 0.05 | 0.1 |
| | min | | 0.00 | 0.18 | | 2.9 | 1.35 | 2.4 | 0.85 | | | 0.2 | 0.3 | | | | |

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

*sot762-1_po*

| Outline version | References | | | | European projection | Issue date |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT762-1 | | MO-241 | | | | ~~15-04-10~~ 15-05-05 |

**Fig. 11. Package outline SOT762-1 (DHVQFN14)**

## 12. Abbreviations

**Table 9. Abbreviations**

| Acronym | Description |
|---|---|
| BiCMOS | Bipolar Complementary Metal Oxide Semiconductor |
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

## 13. Revision history

**Table 10. Revision history**

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|---|---|---|
| 74LVT_LVTH125 v.8 | 20210818 | Product data sheet | - | 74LVT_LVTH125 v.7 |
| Modifications: | • The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.<br>• Legal texts have been adapted to the new company name where appropriate.<br>• Type numbers 74LVT125DB and 74LVTH125DB (SOT337-1/SSOP14) removed.<br>• Section 1 and Section 2 updated.<br>• Fig. 7 aligned with test conditions (errata). | | | |
| 74LVT_LVTH125 v.7 | 20160531 | Product data sheet | - | 74LVT125 v.6 |
| Modifications: | • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.<br>• Legal texts have been adapted to the new company name where appropriate. | | | |
| 74LVT_LVTH125 v.6 | 20060306 | Product data sheet | - | 74LVT125 v.5 |
| Modifications: | • Section 3: Added type numbers 74LVTH125D, 74LVTH125DB, 74LVTH125PW and 74LVTH125BQ. | | | |
| 74LVT125 v.5 | 20050210 | Product data sheet | - | 74LVT125 v.4 |
| 74LVT125 v.4 | 20050207 | Product data sheet | - | 74LVT125 v.3 |
| 74LVT125 v.3 | 20040624 | Product data sheet | - | 74LVT125 v.2 |
| 74LVT125 v.2 | 19980219 | Product specification | - | 74LVT125 v.1 |
| 74LVT125 v.1 | - | - | - | - |

# 14. Legal information

## Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

## Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

## Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

**Right to make changes** — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

**Terms and conditions of commercial sale** — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nexperia.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Non-automotive qualified products** — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

## Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

# Contents





For more information, please visit: http://www.nexperia.com
For sales office addresses, please send an email to: salesaddresses@nexperia.com
**Date of release: 18 August 2021**

单击下面可查看定价，库存，交付和生命周期等信息

>>Nexperia(安世)